

## 5NM80

Power MOSFET

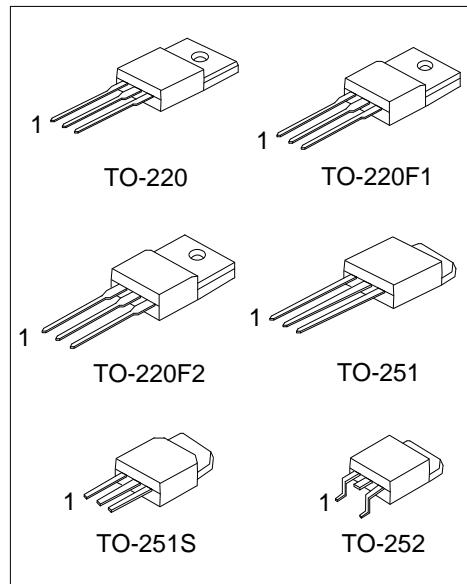
5A, 800V N-CHANNEL  
SUPER-JUNCTION MOSFET

## ■ DESCRIPTION

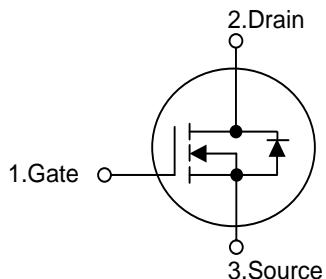
The **UTC 5NM80** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

## ■ FEATURES

- \*  $R_{DS(ON)} \leq 1.62 \Omega$  @  $V_{GS}=10V$ ,  $I_D=2.5A$
- \* Fast switching capability
- \* Avalanche energy tested
- \* Improved dv/dt capability, high ruggedness



## ■ SYMBOL



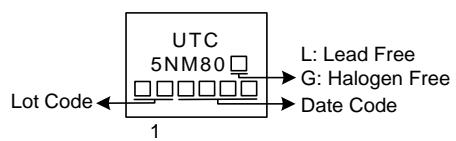
## ■ ORDERING INFORMATION

Ordering Number	Package	Pin Assignment			Packing	
		1	2	3		
Lead Free	Halogen Free					
5NM80L-TA3-T	5NM80G-TA3-T	TO-220	G	D	S	Tube
5NM80L-TF1-T	5NM80G-TF1-T	TO-220F1	G	D	S	Tube
5NM80L-TF2-T	5NM80G-TF2-T	TO-220F2	G	D	S	Tube
5NM80L-TM3-T	5NM80G-TM3-T	TO-251	G	D	S	Tube
5NM80L-TMS-T	5NM80G-TMS-T	TO-251S	G	D	S	Tube
5NM80L-TN3-R	5NM80G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

 5NM80G-TA3-T	(1) T: Tube, R: Tape Reel
	(2) TA3: TO-220, TF1: TO-220F1, TF2: TO-220F2
	TM3: TO-251, TMS: TO-251S, TN3: TO-252
	(3) G: Halogen Free and Lead Free, L: Lead Free

## ■ MARKING



■ ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	800	V
Gate-Source Voltage		$V_{GSS}$	$\pm 30$	V
Drain Current	Continuous $T_C=25^\circ\text{C}$	$I_D$	5	A
			3	A
	Pulsed (Note 2)	$I_{DM}$	10	A
Avalanche Current (Note 2)		$I_{AR}$	1.6	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	48	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2.79	V/ns
Power Dissipation	TO-220	$P_D$	42	W
	TO-220F1/TO-220F2		24	W
	TO-251/TO-251S		36	W
	TO-252			
Junction Temperature		$T_J$	+150	$^\circ\text{C}$
Storage Temperature		$T_{STG}$	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3.  $L=10\text{mH}$ ,  $I_{AS}=3.1\text{A}$ ,  $V_{DD}=50\text{V}$ ,  $R_G=25\ \Omega$ , Starting  $T_J = 25^\circ\text{C}$

4.  $I_{SD} \leq 5.0\text{A}$ ,  $di/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/TO-220F1 TO-220F2	$\theta_{JA}$	62.5	$^\circ\text{C/W}$
	TO-251/TO-251S TO-252		110	$^\circ\text{C/W}$
Junction to Case	TO-220	$\theta_{JC}$	2.98	$^\circ\text{C/W}$
	TO-220F1/TO-220F2		5.21	$^\circ\text{C/W}$
	TO-251/TO-251S TO-252		3.47 (Note)	$^\circ\text{C/W}$

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

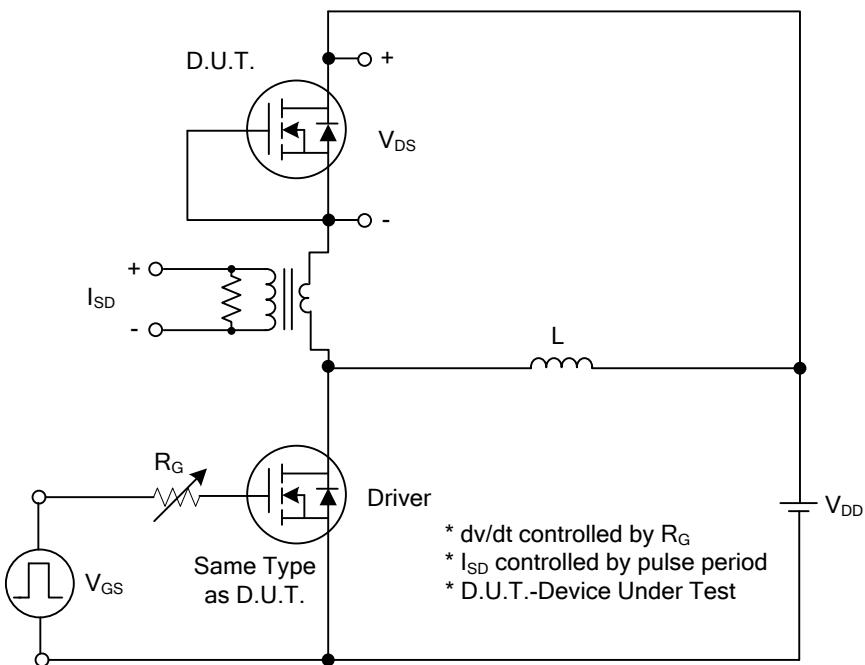
■ ELECTRICAL CHARACTERISTICS ( $T_J=25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = 250\mu\text{A}$	800			V
Drain-Source Leakage Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 800\text{V}, V_{\text{GS}} = 0\text{V}$		10		$\mu\text{A}$
Gate-Source Leakage Current	Forward	$V_{\text{GS}} = 30\text{V}, V_{\text{DS}} = 0\text{V}$		100	nA	
	Reverse	$V_{\text{GS}} = -30\text{V}, V_{\text{DS}} = 0\text{V}$		-100	nA	
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{\text{GS(TH)}}$	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = 250\mu\text{A}$	2.5		4.5	V
Static Drain-Source On-State Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}} = 10\text{V}, I_{\text{D}} = 2.5\text{A}$		1.62		$\Omega$
<b>DYNAMIC CHARACTERISTICS</b>						
Input Capacitance	$C_{\text{ISS}}$	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, f=1.0\text{MHz}$		430		pF
Output Capacitance	$C_{\text{OSS}}$			230		pF
Reverse Transfer Capacitance	$C_{\text{RSS}}$			11		pF
<b>SWITCHING CHARACTERISTICS</b>						
Total Gate Charge (Note 1)	$Q_G$	$V_{\text{DS}}=640\text{V}, I_{\text{D}}=5\text{A}, I_{\text{G}}=1\text{mA}$ $V_{\text{GS}}=10\text{V}$ (Note 1,2)		18		nC
Gate to Source Charge	$Q_{\text{GS}}$			3.5		nC
Gate to Drain Charge	$Q_{\text{GD}}$			5.5		nC
Turn-ON Delay Time (Note 1)	$t_{\text{D(ON)}}$	$V_{\text{DD}}=100\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=5\text{A}, R_{\text{G}}=25\Omega$ , (Note 1,2)		5		nS
Rise Time	$t_R$			18.5		nS
Turn-OFF Delay Time	$t_{\text{D(OFF)}}$			50		nS
Fall-Time	$t_F$			29.5		nS
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Maximum Continuous Drain-Source Diode Forward Current	$I_S$				5	A
Maximum Pulsed Drain-Source Diode Forward Current	$I_{\text{SM}}$				20	A
Drain-Source Diode Forward Voltage (Note 1)	$V_{\text{SD}}$	$I_S=5.0\text{A}, V_{\text{GS}}=0\text{V}$			1.4	V
Body Diode Reverse Recovery Time (Note 1)	$t_{\text{rr}}$	$I_S=5.0\text{A}, V_{\text{GS}}=0\text{V}$ $dI_F/dt=100\text{A}/\mu\text{s}$		350		nS
Body Diode Reverse Recovery Charge	$Q_{\text{rr}}$			3.5		$\mu\text{C}$

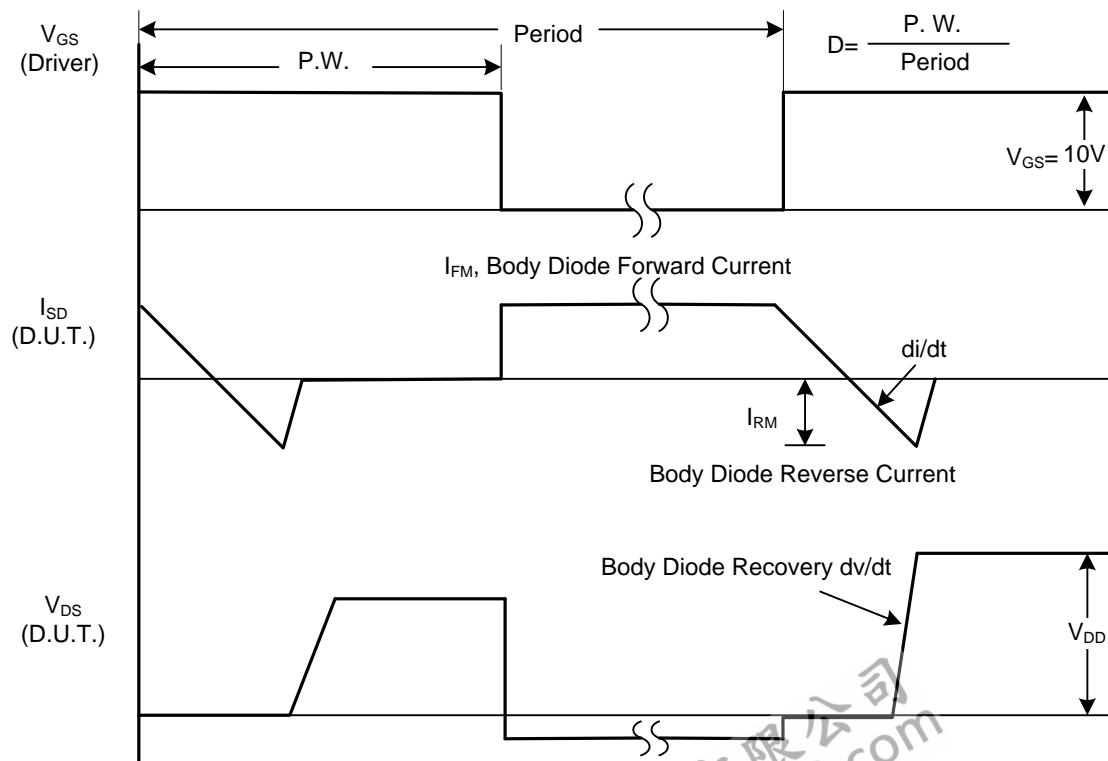
Notes: 1. Pulse Test : Pulse width  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$ .

2. Essentially independent of operating ambient temperature.

## ■ TEST CIRCUITS AND WAVEFORMS

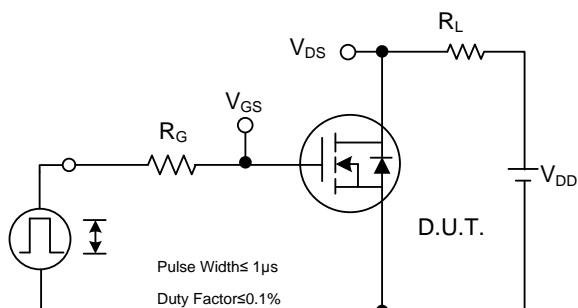


Peak Diode Recovery dv/dt Test Circuit

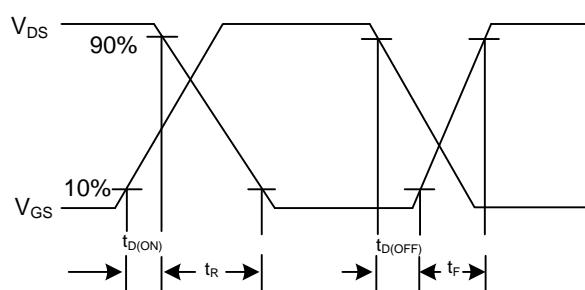


Peak Diode Recovery dv/dt Waveforms

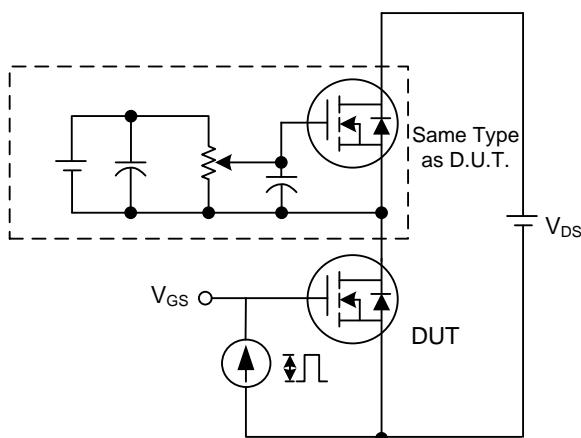
## ■ TEST CIRCUITS AND WAVEFORMS



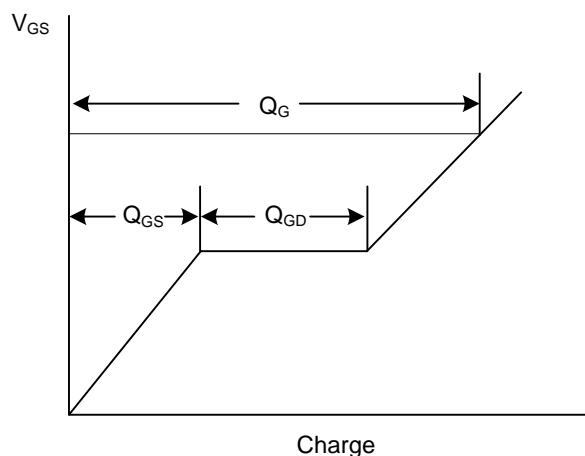
Switching Test Circuit



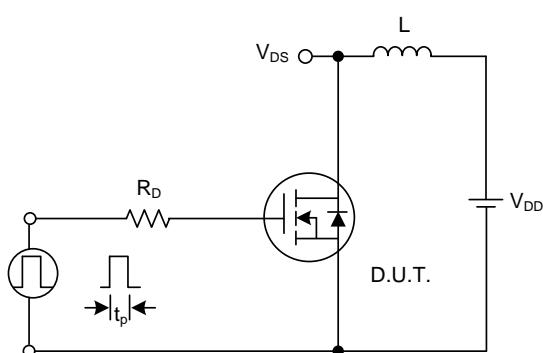
Switching Waveforms



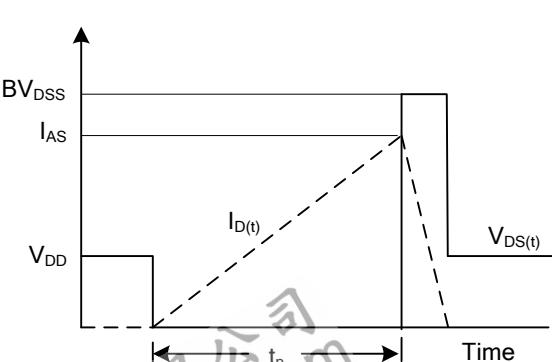
Gate Charge Test Circuit



Gate Charge Waveform

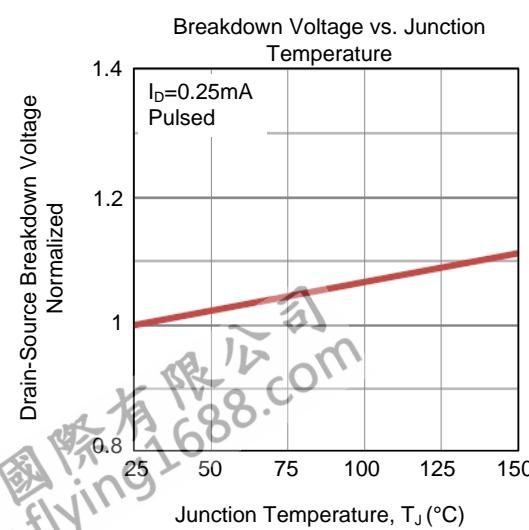
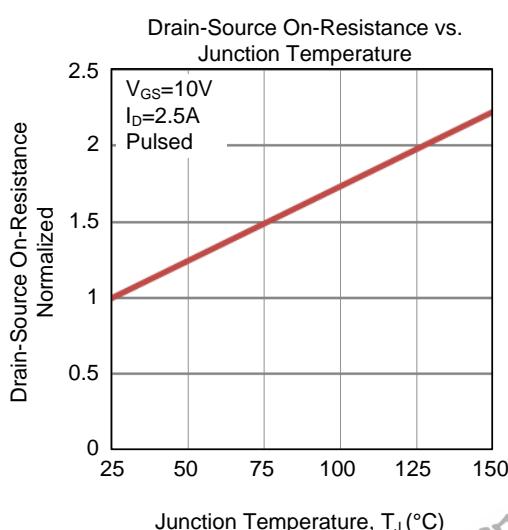
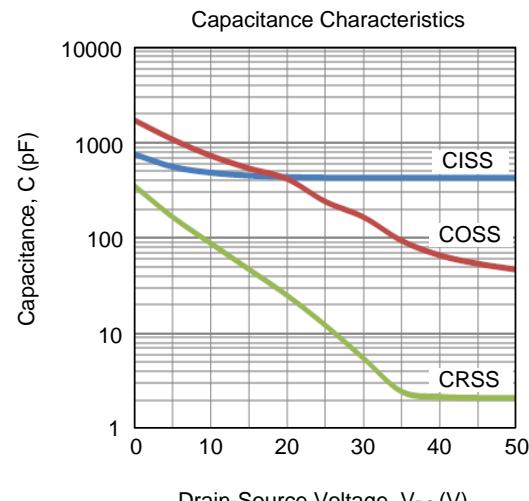
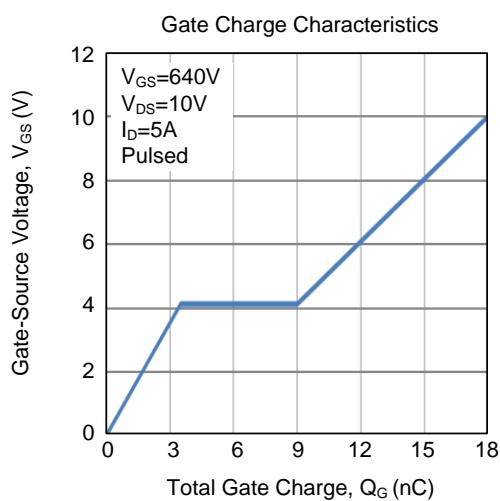
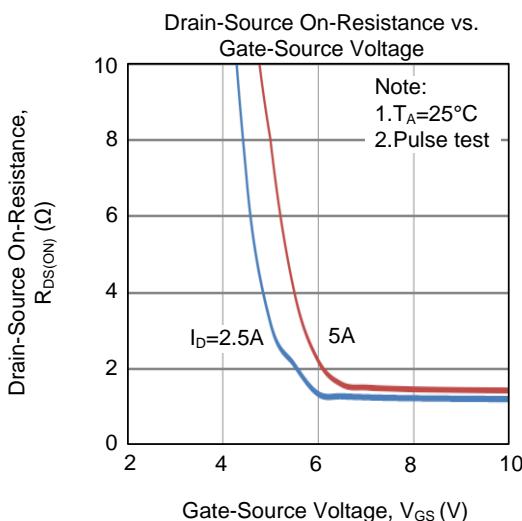
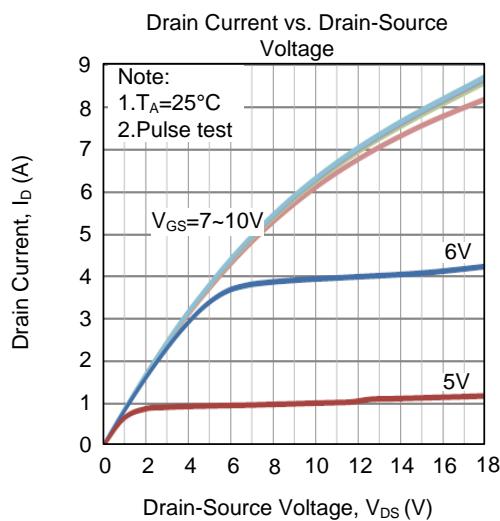


Unclamped Inductive Switching Test Circuit

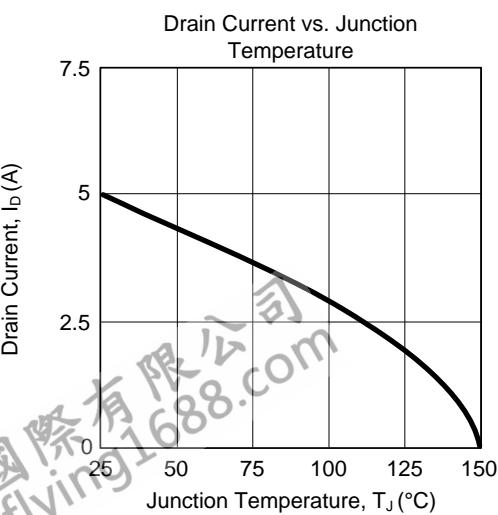
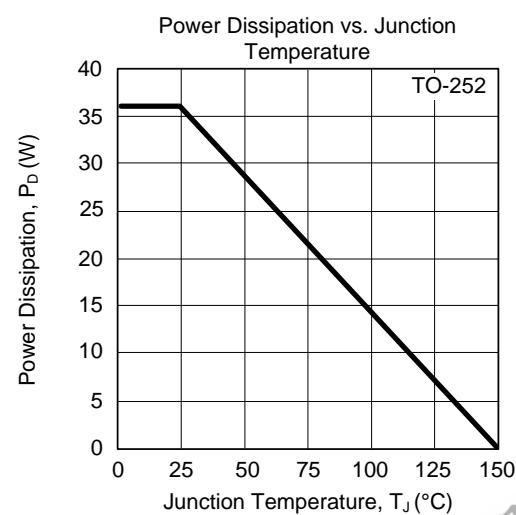
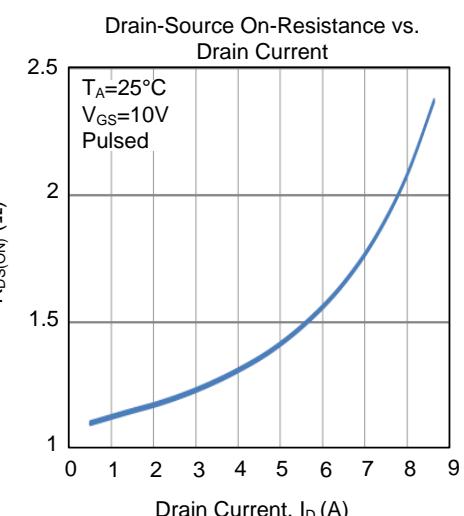
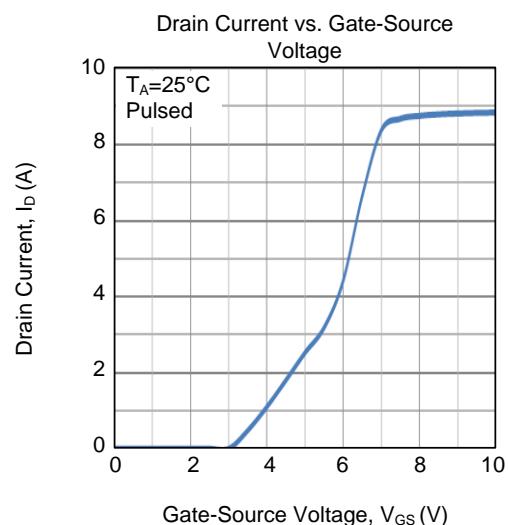
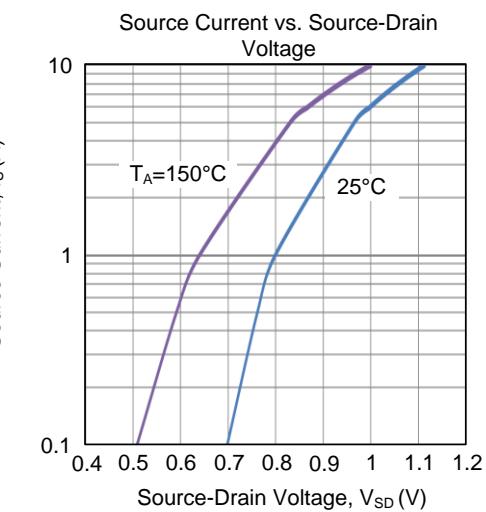
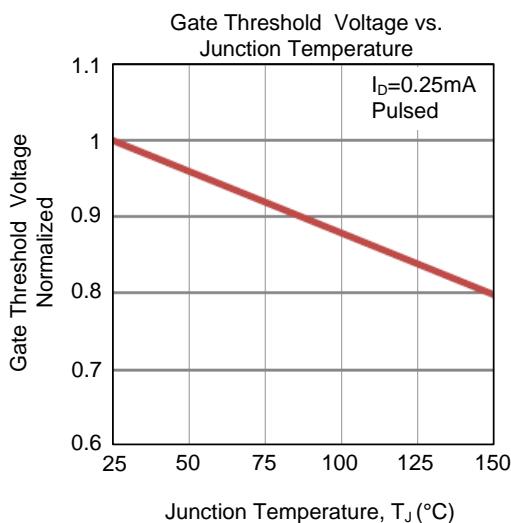


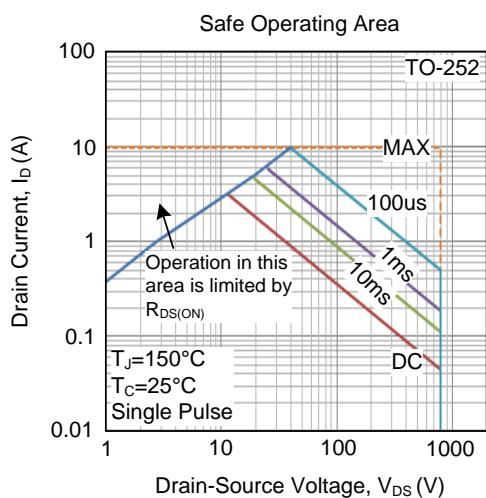
Unclamped Inductive Switching Waveforms

## ■ TYPICAL CHARACTERISTICS



## ■ TYPICAL CHARACTERISTICS (Cont.)



**■ TYPICAL CHARACTERISTICS (Cont.)**

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